TOSHIBA THYRISTOR SILICON PLANAR TYPE

SF16GZ51, SF16JZ51

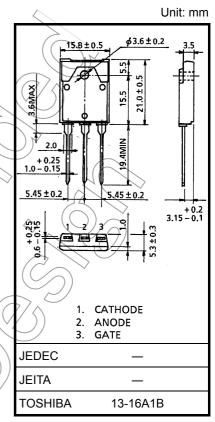
MEDIUM POWER CONTROL APPLICATIONS

- Repetitive Peak Off-State Voltage: V_{DRM} = 400V,600V
 Repetitive Peak Reverse Voltage: V_{RRM} = 400V,600V
- Average On-State Current: IT (AV) = 16A
- Isolation Voltage: $V_{Isol} = 1500V$ AC

MAXIMUM RATINGS

CHARACTERISTIC		SYMBOL	RATING	UNIT	
Repetitive Peak Off-State Voltage and	SF16GZ51	V_{DRM}	400		
Repetitive Peak Reverse Voltage	SF16JZ51	V_{RRM}	600		
Non-Repetitive Peak Reverse Voltage (Non-Repetitive <5ms, Tj = 0~125°C)	SF16GZ51	V	500	\\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\	
	SF16JZ51	V _{RSM}	720	V	
Average On-State Current (Half Sine Waveform)		I _{T(AV)}	16	A	
R.M.S On-State Current		I _{T(RMS)}	25	< <a>A	
Peak One Cycle Surge On-State Current (Non-Repetitive)		ITSM	250 (50Hz) 275 (60Hz)	A	
I ² t Limit Value		(I ² t \)	312	A ² s	
Critical Rate of Rise of C Curret	n-State (Note)	di / dt	100	ALus	
Peak Gate Power Dissip	ation	PGM	5	\rightarrow_{W}	
Average Gate Power Dis	sipation	P _G (AV)	(0.5/))	W	
Peak Forward Gate Voltage		V_{FGM}	10	٧	
Peak Reverse Gate Voltage		V _{RGM}	-5	V	
Peak Forward Gate Current		I _{GM}	2	Α	
Junction Temperature		<i>T</i> 1>	-40~125	°C	
Storage Temperature Range		Tstg	-40~125	°C	
Isolation Voltage (AC, t = 1min.)		Visol	1500	V	

Note: di/dt Test Condition, $t_{G} = 30$ mA, $t_{gw} = 10$ µs, $t_{gr} \le 250$ ns

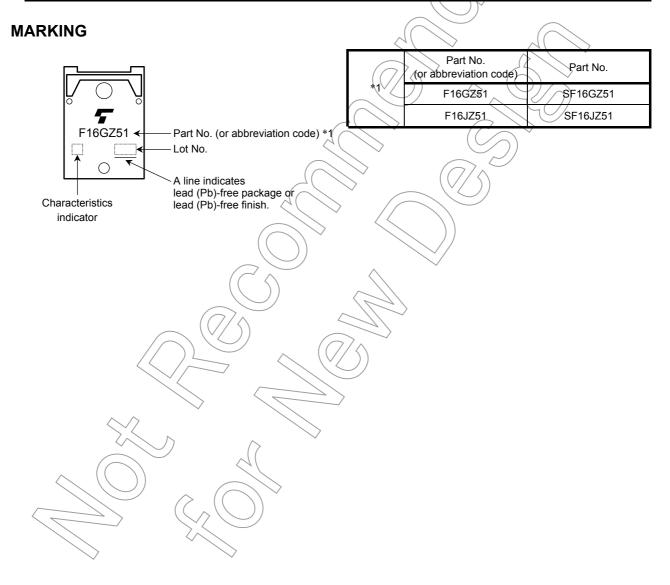


Weight: 5.9 g (typ.)

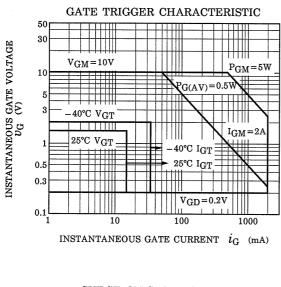


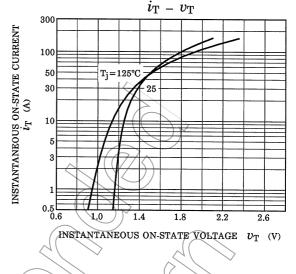
ELECTRICAL CHARACTERISTICS (Ta = 25°C)

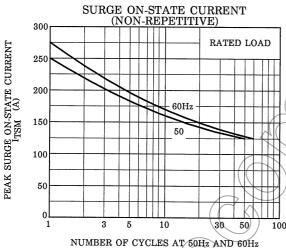
CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
Repetitive Peak Off-State Current and Repetitive Peak Reverse Current	I _{DRM} I _{RRM}	V _{DRM} = V _{RRM} = Rated	_	_	20	μΑ
Peak On-State Voltage	V _{TM}	I _{TM} = 50A	_	_	1.5	V
Gate Trigger Voltage	V _{GT}	$V_D = 6V, R_1 = 10\Omega$	\nearrow	_	1.5	V
Gate Trigger Current	I _{GT}	1 VD - 6V, KL - 1012	(-)	7	15	mA
Holding Current	lΗ	V _D = 6V, I _{TM} = 500mA		7 –	50	mA
Critical Rate of Rise of Off-State Voltage	dv / dt	V _{DRM} = Rated, Tc = 125°C Exponential Rise	\bigcirc	50	_	V / µs
Thermal Resistance	R _{th (j-c)}	Junction to Case	_	_	1.5	°C / W

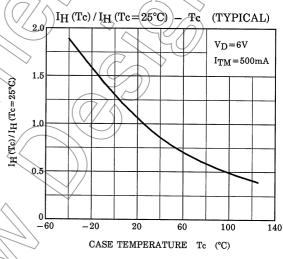


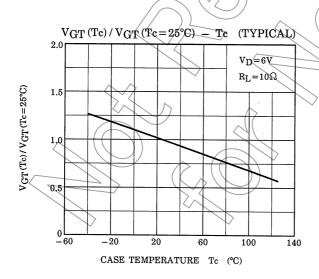
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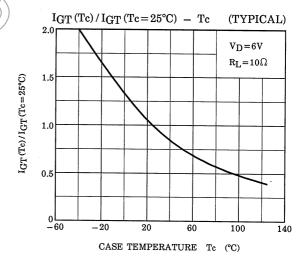


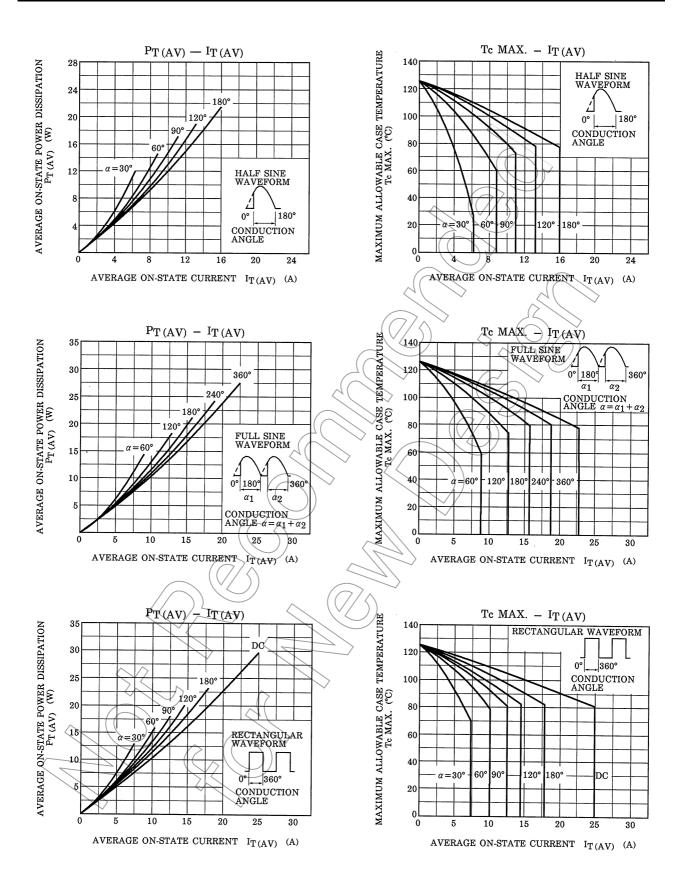


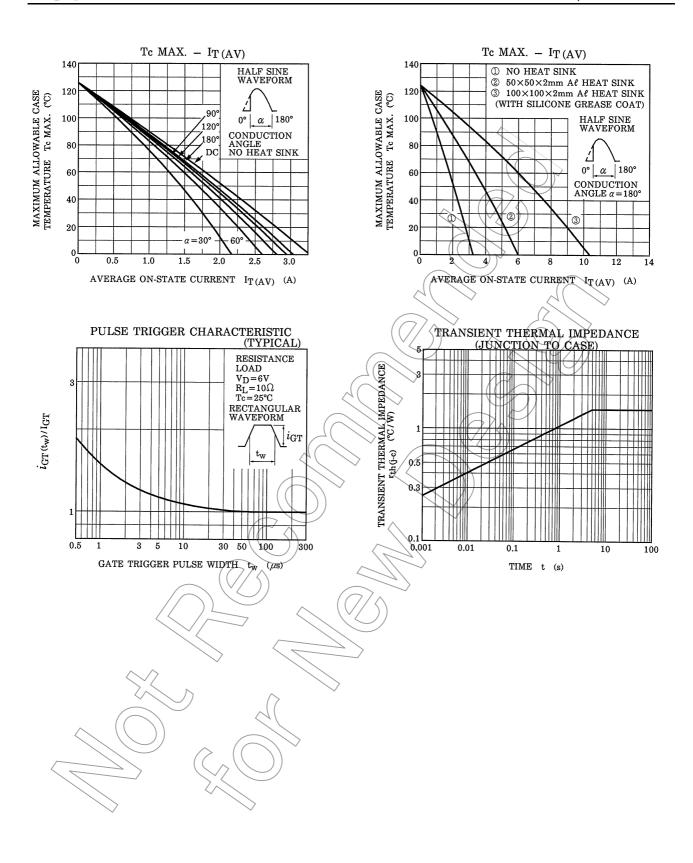














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2004-07-06